

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5347575

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JIANBIN KANG	12/17/2018
JIAN GAO	12/17/2018
JIBING DONG	12/17/2018
RUIYONG JIA	12/18/2018
XINLEI XU	12/18/2018
XIONGCHENG LI	12/18/2018
RECEIVING PARTY DATA	
Name:	EMC IP HOLDING COMPANY LLC
Street Address:	176 SOUTH STREET
City:	HOPKINTON
State/Country:	MASSACHUSETTS
Postal Code:	01748
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16223843
CORRESPONDENCE DATA	
Fax Number:	(508)366-4688
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	508-616-2900
Email:	Docket@BainwoodHuang.com
Correspondent Name:	BAINWOOD, HUANG & ASSOCIATES, LLC
Address Line 1:	2 CONNECTOR ROAD
Address Line 4:	WESTBOROUGH, MASSACHUSETTS 01581
ATTORNEY DOCKET NUMBER:	1003-627
NAME OF SUBMITTER:	DAVID E. HUANG, ESQ.
SIGNATURE:	/David E. Huang, Reg. No. 39,229/
DATE SIGNED:	01/29/2019
Total Attachments: 18	

source=1003-627-Inv1-assignment-KANG#page1.tif
source=1003-627-Inv1-assignment-KANG#page2.tif
source=1003-627-Inv1-assignment-KANG#page3.tif
source=1003-627-Inv2-assignment-GAO#page1.tif
source=1003-627-Inv2-assignment-GAO#page2.tif
source=1003-627-Inv2-assignment-GAO#page3.tif
source=1003-627-Inv3-assignment-DONG#page1.tif
source=1003-627-Inv3-assignment-DONG#page2.tif
source=1003-627-Inv3-assignment-DONG#page3.tif
source=1003-627-Inv4-assignment-JIA#page1.tif
source=1003-627-Inv4-assignment-JIA#page2.tif
source=1003-627-Inv4-assignment-JIA#page3.tif
source=1003-627-Inv5-assignment-XU#page1.tif
source=1003-627-Inv5-assignment-XU#page2.tif
source=1003-627-Inv5-assignment-XU#page3.tif
source=1003-627-Inv6-assignment-LI#page1.tif
source=1003-627-Inv6-assignment-LI#page2.tif
source=1003-627-Inv6-assignment-LI#page3.tif

ASSIGNMENT

WHEREAS, I, Jianbin Kang, as the original inventor or an original joint inventor have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled

**METHOD, DEVICE AND COMPUTER PROGRAM PRODUCT FOR DETECTING
INCOMPLETE WRITE OF DATA**

which is further identified by Attorney Docket Number 1003-627;

WHEREAS, EMC IP Holding Company LLC (hereinafter "ASSIGNEE"), a limited liability company organized and existing under the laws of the state of Delaware and having a usual place of business at 176 South Street, Hopkinton, MA, 01748, USA, desires to acquire an interest therein in accordance with agreements duly entered into with me;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, I have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by me had this assignment and sale not been made; I hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. I hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, I hereby further agree for myself and my executors and administrators to execute upon request any other lawful documents and likewise to perform any other

lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, I do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives;

AND I hereby authorize the attorneys at Bainwood Huang & Associates LLC to insert here in parentheses

(16/223,843 , filed 12/18/18)

the application number and filing date of said application (or foreign counterpart application) to facilitate the recording or other official processing of this Assignment.

Date: 2018.12.17

Jianbin Kang
Inventor's Signature

Legal name of inventor: Jianbin Kang
Residence: #902, Building 13, Wenhui Yuan
Haidian District
Beijing, 100082
China (People's Republic)
Mailing Address: Same as Above
Citizenship: CN

I Hongpo Guo (name) whose residential address is
7/F, Block D, Tsinghua Science Park, Haidian District, Beijing
was personally present and did see Jianbin Kang (name of person signing the
assignment) who is personally known to me, execute the above assignment.

Hongpo Guo (signature of first witness)

Signed at 7/F, Block D, TSP (location of witness signature)

on this day 12.18 of 20 18. (date of signature)

I Lei Sun (name) whose residential address is
7/F, Block D, Tsinghua Science Park, Haidian District, Beijing, P.R.C
was personally present and did see Jianbin Kang (name of person signing the
assignment) who is personally known to me, execute the above assignment.

Lei Sun (signature of second witness)

Signed at 7/F, Block D, Tsinghua Science Park (location of witness signature)

on this day 12.18 of 20 18. (date of signature)

ASSIGNMENT

WHEREAS, I, Jian Gao, as the original inventor or an original joint inventor have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled

**METHOD, DEVICE AND COMPUTER PROGRAM PRODUCT FOR DETECTING
INCOMPLETE WRITE OF DATA**

which is further identified by Attorney Docket Number 1003-627;

WHEREAS, EMC IP Holding Company LLC (hereinafter "ASSIGNEE"), a limited liability company organized and existing under the laws of the state of Delaware and having a usual place of business at 176 South Street, Hopkinton, MA, 01748, USA, desires to acquire an interest therein in accordance with agreements duly entered into with me;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, I have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by me had this assignment and sale not been made; I hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. I hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, I hereby further agree for myself and my executors and administrators to execute upon request any other lawful documents and likewise to perform any other

lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

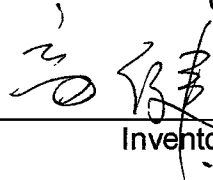
AND, I do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives;

AND I hereby authorize the attorneys at Bainwood Huang & Associates LLC to insert here in parentheses

(16/223,843 , filed 12/18/18)

the application number and filing date of said application (or foreign counterpart application) to facilitate the recording or other official processing of this Assignment.

Date: 2018.12.17



Inventor's Signature

Legal name of inventor: Jian Gao
Residence: 3-1-705, Lianhuahe Bei Street 11
Xicheng District
Beijing, 100000
China (People's Republic)
Mailing Address: Same as Above
Citizenship: CN

I Hongpo Gao (name) whose residential address is
7/F, Block D, Tsinghua Science Park, Haidian District, Beijing
was personally present and did see Jian Gao (name of person signing the assignment)
who is personally known to me, execute the above assignment.

Hongpo Gao (signature of first witness)

Signed at 7/F, Block D, TSP (location of witness signature)

on this day 12.15 of 20 18. (date of signature)

I Lei Sun (name) whose residential address is
7/F, Block D, Tsinghua Science Park, Haidian District, Beijing, P.R.C
was personally present and did see Jian Gao (name of person signing the assignment)
who is personally known to me, execute the above assignment.

Lei Sun (signature of second witness)

Signed at 7/F, Block D, Tsinghua Science Park (location of witness signature)

on this day 12.18 of 20 18. (date of signature)

ASSIGNMENT

WHEREAS, I, Jibing Dong, as the original inventor or an original joint inventor have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled

**METHOD, DEVICE AND COMPUTER PROGRAM PRODUCT FOR DETECTING
INCOMPLETE WRITE OF DATA**

which is further identified by Attorney Docket Number 1003-627;

WHEREAS, EMC IP Holding Company LLC (hereinafter "ASSIGNEE"), a limited liability company organized and existing under the laws of the state of Delaware and having a usual place of business at 176 South Street, Hopkinton, MA, 01748, USA, desires to acquire an interest therein in accordance with agreements duly entered into with me;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, I have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by me had this assignment and sale not been made; I hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. I hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, I hereby further agree for myself and my executors and administrators to execute upon request any other lawful documents and likewise to perform any other

lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, I do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives;

AND I hereby authorize the attorneys at Bainwood Huang & Associates LLC to insert here in parentheses

(16/223,843 , filed 12/18/18)

the application number and filing date of said application (or foreign counterpart application) to facilitate the recording or other official processing of this Assignment.

Date: 2018/12/17

Jibing Dong
Inventor's Signature

Legal name of inventor: Jibing Dong
Residence: #5-2-2903, Zhong Jian Guo Ji GanG
Xing Hua Road, Daxing District
Beijing, 1002600
China (People's Republic)
Mailing Address: Same as Above
Citizenship: CN

I Hongpo Gao (name) whose residential address is
7F, Block D, Tsinghua Science Park, Hai Dian District, Beijing
was personally present and did see Jibing Dong (name of person signing the
assignment) who is personally known to me, execute the above assignment.

Hongpo Gao (signature of first witness)

Signed at 7F, Block D, TSP (location of witness signature)

on this day 12.18 of 2018. (date of signature)

I Lei Sun (name) whose residential address is
71F, Block D, Tsinghua Science Park, Hai Dian District, Beijing, P.R.C
was personally present and did see Jibing Dong (name of person signing the
assignment) who is personally known to me, execute the above assignment.

Lei Sun (signature of second witness)

Signed at 71F, Block D, Tsinghua Science Park (location of witness signature)

on this day 12.18 of 2018. (date of signature)

ASSIGNMENT

WHEREAS, I, Ruiyong Jia, as the original inventor or an original joint inventor have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled

**METHOD, DEVICE AND COMPUTER PROGRAM PRODUCT FOR DETECTING
INCOMPLETE WRITE OF DATA**

which is further identified by Attorney Docket Number 1003-627;

WHEREAS, EMC IP Holding Company LLC (hereinafter "ASSIGNEE"), a limited liability company organized and existing under the laws of the state of Delaware and having a usual place of business at 176 South Street, Hopkinton, MA, 01748, USA, desires to acquire an interest therein in accordance with agreements duly entered into with me;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, I have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by me had this assignment and sale not been made; I hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. I hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, I hereby further agree for myself and my executors and administrators to execute upon request any other lawful documents and likewise to perform any other

lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, I do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives;

AND I hereby authorize the attorneys at Bainwood Huang & Associates LLC to insert here in parentheses

(16/223,843 , filed 12/18/18)

the application number and filing date of said application (or foreign counterpart application) to facilitate the recording or other official processing of this Assignment.

Date: 2018.12.18

Ruiyong Jia
Inventor's Signature

Legal name of inventor: Ruiyong Jia
Residence: Room 1-403, Building 27, No. 105
XiSanHuanBeiLu
Beijing, 100010
China (People's Republic)
Mailing Address: Same as Above
Citizenship: CN

I Hongpo Gao (name) whose residential address is
7/F, Block D, Tsinghua Science Park, Haidian District, Beijing.
was personally present and did see Ruiyong Jia (name of person signing the
assignment) who is personally known to me, execute the above assignment.

Hongpo Gao (signature of first witness)

Signed at 7/F, Block D, TSP (location of witness signature)

on this day 12.18 of 20 18. (date of signature)

I Lei Sun (name) whose residential address is
7/F, Block D, Tsinghua Science Park, Haidian District, Beijing, P.R.C.
was personally present and did see Ruiyong Jia (name of person signing the
assignment) who is personally known to me, execute the above assignment.

Lei Sun (signature of second witness)

Signed at 7/F, Block D, Tsinghua Science Park. (location of witness signature)

on this day 12.18 of 20 18. (date of signature)

ASSIGNMENT

WHEREAS, I, Xinlei Xu, as the original inventor or an original joint inventor have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled

**METHOD, DEVICE AND COMPUTER PROGRAM PRODUCT FOR DETECTING
INCOMPLETE WRITE OF DATA**

which is further identified by Attorney Docket Number 1003-627;

WHEREAS, EMC IP Holding Company LLC (hereinafter "ASSIGNEE"), a limited liability company organized and existing under the laws of the state of Delaware and having a usual place of business at 176 South Street, Hopkinton, MA, 01748, USA, desires to acquire an interest therein in accordance with agreements duly entered into with me;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, I have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by me had this assignment and sale not been made; I hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. I hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, I hereby further agree for myself and my executors and administrators to execute upon request any other lawful documents and likewise to perform any other

lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, I do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives;

AND I hereby authorize the attorneys at Bainwood Huang & Associates LLC to insert here in parentheses

(16/223,843 , filed 12/18/18)

the application number and filing date of said application (or foreign counterpart application) to facilitate the recording or other official processing of this Assignment.

Date: 2018.12.18 Xinlei Xu
Inventor's Signature

Legal name of inventor: Xinlei Xu
Residence: 6-6-602, Tiantongyuan Zhong Yuan
Changping
Beijing, 102218
China (People's Republic)
Mailing Address: Same as Above
Citizenship: CN

I Hongpo Gao (name) whose residential address is
7F, Block D, Tsinghua Science Park, Haidian District, Beijing
was personally present and did see Xinlei Xu (name of person signing the assignment)
who is personally known to me, execute the above assignment.

Hongpo Gao (signature of first witness)

Signed at 7F, Block D, TSP (location of witness signature)

on this day 12.18 of 20 18. (date of signature)

I Lei Sun (name) whose residential address is
71F, Block D, Tsinghua Science Park, Haidian District, Beijing, P.R.C.
was personally present and did see Xinlei Xu (name of person signing the assignment)
who is personally known to me, execute the above assignment.

Lei Sun (signature of second witness)

Signed at 71F, Block D, Tsinghua Science Park (location of witness signature)

on this day 12.18 of 20 18. (date of signature)

ASSIGNMENT

WHEREAS, I, Xiongcheng Li, as the original inventor or an original joint inventor have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled

**METHOD, DEVICE AND COMPUTER PROGRAM PRODUCT FOR DETECTING
INCOMPLETE WRITE OF DATA**

which is further identified by Attorney Docket Number 1003-627;

WHEREAS, EMC IP Holding Company LLC (hereinafter "ASSIGNEE"), a limited liability company organized and existing under the laws of the state of Delaware and having a usual place of business at 176 South Street, Hopkinton, MA, 01748, USA, desires to acquire an interest therein in accordance with agreements duly entered into with me;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, I have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by me had this assignment and sale not been made; I hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. I hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, I hereby further agree for myself and my executors and administrators to execute upon request any other lawful documents and likewise to perform any other

lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, I do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives;

AND I hereby authorize the attorneys at Bainwood Huang & Associates LLC to insert here in parentheses

(16/223,843 , filed ~~8~~ 12/18/18)

the application number and filing date of said application (or foreign counterpart application) to facilitate the recording or other official processing of this Assignment.

Date: 2018/12/18

Xiongcheng Li
Inventor's Signature

Legal name of inventor: Xiongcheng Li
Residence: Longhuiyuan 1-3-401, Huilongguan
Changping District
Beijing, 102208
China (People's Republic)
Mailing Address: Same as Above
Citizenship: CN

I Hongpo Gao (name) whose residential address is
7/F, Block D, Tsinghua Science Park, Haidian District Beijing
was personally present and did see Xiongcheng Li (name of person signing the
assignment) who is personally known to me, execute the above assignment.

Hongpo Gao (signature of first witness)

Signed at 7/F, Block D, TSP (location of witness signature)

on this day 12, 18 of 20 18. (date of signature)

I Lei Sun (name) whose residential address is
7/F, Block D, Tsinghua Science Park, Haidian District, Beijing, P.R.C.
was personally present and did see Xiongcheng Li (name of person signing the
assignment) who is personally known to me, execute the above assignment.

Lei Sun (signature of second witness)

Signed at 7/F, Block D, Tsinghua Science Park (location of witness signature)

on this day 12. 18 of 20 18. (date of signature)